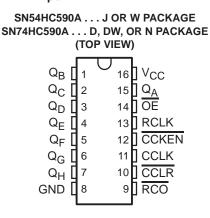
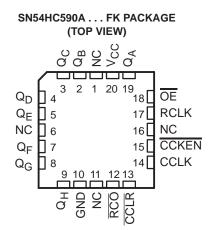
SN54HC590A, SN74HC590A 8-BIT BINARY COUNTERS WITH 3-STATE OUTPUT REGISTERS SCLS039F – DECEMBER 1982 – REVISED SEPTEMBER 2003

- 2-V to 6-V V_{CC} Operation
- High-Current 3-State Parallel Register Outputs Can Drive Up To 15 LSTTL Loads
- Low Power Consumption, 80-µA Max I_{CC}
- Typical t_{pd} = 14 ns



- ±6-mA Output Drive at 5 V
- Low Input Current of 1 μA Max
- 8-Bit Counter With Register
- Counter Has Direct Clear



NC - No internal connection

description/ordering information

The 'HC590A devices contain an 8-bit binary counter that feeds an 8-bit storage register. The storage register has parallel outputs. Separate clocks are provided for both the binary counter and storage register. The binary counter features direct clear (CCLR) and count-enable (CCKEN) inputs. A ripple-carry output (RCO) is provided for cascading. Expansion is accomplished easily for two stages by connecting RCO of the first stage to CCKEN of the second stage. Cascading for larger count chains can be accomplished by connecting RCO of each stage to the counter clock (CCLK) input of the following stage.

CCLK and the register clock (RCLK) inputs are positive-edge triggered. If both clocks are connected together, the counter state always is one count ahead of the register. Internal circuitry prevents clocking from the clock enable.

Τ _Α	PAC	Tube of 25 SN74HC59 Tube of 40 SN74HC59 Reel of 2500 SN74HC59 Reel of 2500 SN74HC59 Tube of 40 SN74HC59 Reel of 2500 SN74HC59 Tube of 40 SN74HC59 Tube of 40 SN74HC59 Tube of 250 SN74HC59 Tube of 2000 SN74HC59 Tube of 25 SNJ54HC59	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – N	Tube of 25	SN74HC590AN	SN74HC590AN
		Tube of 40	SN74HC590AD	
40°C to 85°C	SOIC – D	Reel of 2500	SN74HC590ADR	HC590A
–40°C to 85°C		Reel of 250	SN74HC590ADT	
		Tube of 40	SN74HC590ADW	1105004
	SOIC – DW	Reel of 2000	SN74HC590ADWR	HC590A
	CDIP – J	Tube of 25	SNJ54HC590AJ	SNJ54HC590AJ
–55°C to 125°C	CFP – W	Tube of 150	SNJ54HC590AW	SNJ54HC590AW
	LCCC - FK	Tube of 55	SNJ54HC590AFK	SNJ54HC590AFK

ORDERING INFORMATION

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

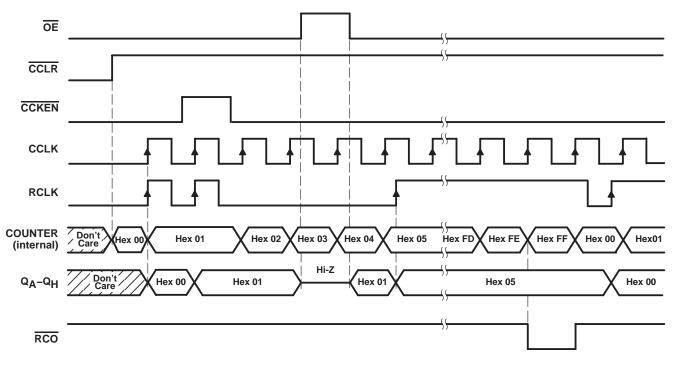


Copyright © 2003, Texas Instruments Incorporated On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

SN54HC590A, SN74HC590A **8-BIT BINARÝ COUNTERS** WITH 3-STATE OUTPUT REGISTERS

SCLS039F - DECEMBER 1982 - REVISED SEPTEMBER 2003

timing diagram

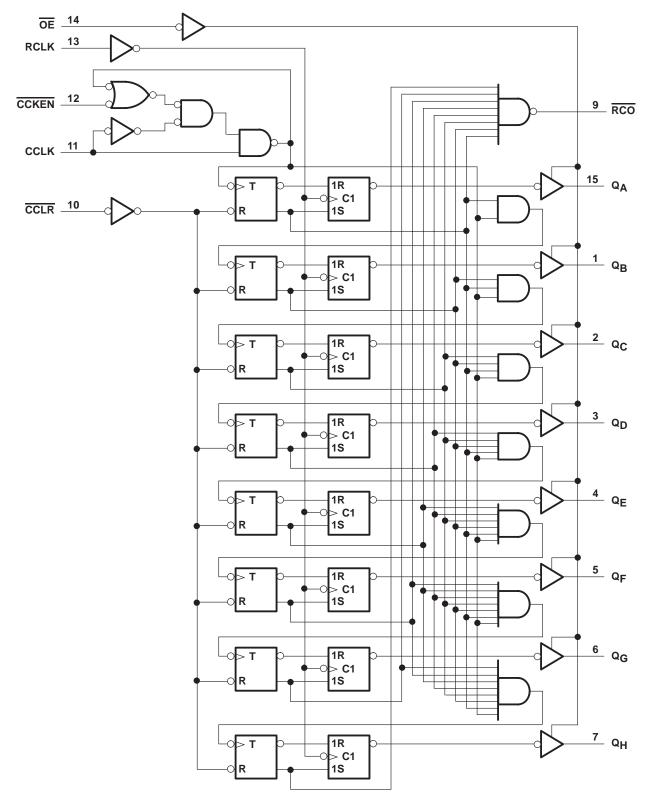


TIMING SEQUENCE

- 1. Clear Counter (asynchronous).
- 2. Count up: 0x01. Store 0x00 in register.
- 3. Inhibit counter clock (CCKEN = HIGH). Store 0x01 in register.
- 4. Count 0x02, 0x03.
- 5. 3-state the outputs
- 6. Count up: 0x04
- 7. Enable outputs.
- 8. Continue up: 0x05
- 9. Store 0x05 in register.
- 10. Continue counting: 0x06...0xFD, 0xFE, 0xFF, 0x00, etc.
- 11. Store 0x00 in register.



logic diagram (positive logic)



Pin numbers shown are for the D, DW, J, N, and W packages.



SN54HC590A, SN74HC590A **8-BIT BINARY COUNTERS** WITH 3-STATE OUTPUT REGISTERS

SCLS039F - DECEMBER 1982 - REVISED SEPTEMBER 2003

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC} Input clamp current, I_{IK} (V_I < 0 or V_I > V_{CC}) (see		
Output clamp current, I_{OK} (V _O < 0 or V _O > V _{CO}		
Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC})$		
Continuous current through V _{CC} or GND		±70 mA
Package thermal impedance, θ_{JA} (see Note 2):	: D package	73°C/W
	DW package	57°C/W
	N package	67°C/W
Storage temperature range, Tstg		–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 3)

			SN	54HC59	0A	SN	74HC590)A	
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage		2	5	6	2	5	6	V
		$V_{CC} = 2 V$	1.5			1.5			
VIH	High-level input voltage	$V_{CC} = 4.5 V$	3.15			3.15			V
		VCC = 6 V	4.2			4.2			
		$V_{CC} = 2 V$			0.5			0.5	
VIL	Low-level input voltage	V _{CC} = 4.5 V			1.35			1.35	V
		VCC = 6 V			1.8			1.8	
VI	Input voltage		0		VCC	0		VCC	V
VO	Output voltage		0		VCC	0		VCC	V
		$V_{CC} = 2 V$			1000			1000	
tt‡	Input transition (rise and fall) time	V _{CC} = 4.5 V			500			500	ns
		$V_{CC} = 6 V$			400			400	
ТА	Operating free-air temperature		-55		125	-40		85	°C

[‡] If this device is used in the threshold region (from V_{IL}max = 0.5 V to V_{IH}min = 1.5 V), there is a potential to go into the wrong state from induced grounding, causing double clocking. Operating with the inputs at tt = 1000 ns and V_{CC} = 2 V does not damage the device; however, functionally, the CCLK and RCLK inputs are not ensured while in the shift, count, or toggle operating modes.

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



SN54HC590A, SN74HC590A 8-BIT BINARY COUNTERS WITH 3-STATE OUTPUT REGISTERS SCLS039F - DECEMBER 1982 - REVISED SEPTEMBER 2003

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

				Т	A = 25°C	;	SN54H	C590A	SN74H	C590A	
PARAMETER	IEST	CONDITIONS	vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
			2 V	1.9	1.998		1.9		1.9		
		I _{OH} = -20 μA	4.5 V	4.4	4.499		4.4		4.4		
			6 V	5.9	5.999		5.9		5.9		
VOH	$V_I = V_{IH} \text{ or } V_{IL}$	\overline{RCO} , $I_{OH} = -4 \text{ mA}$	4.5.1	3.98	4.3		3.7		3.84		V
		$Q_A - Q_H$, $I_{OH} = -6 \text{ mA}$	4.5 V	3.98	4.3		3.7		3.84		
		RCO, I _{OH} = -5.2 mA	6 V	5.48	5.8		5.2		5.34		
		Q_A-Q_H , $I_{OH} = -7.8$ mA	бV	5.48	5.8		5.2		5.34		
			2 V		0.002	0.1		0.1		0.1	
		I _{OL} = 20 μA	4.5 V		0.001	0.1		0.1		0.1	
			6 V		0.001	0.1		0.1		0.1	
VOL	$V_I = V_{IH} \text{ or } V_{IL}$	RCO, I _{OL} = 4 mA	451		0.17	0.26		0.4		0.33	V
		$Q_A - Q_H$, $I_{OL} = 6 \text{ mA}$	4.5 V		0.17	0.26		0.4		0.33	
		RCO, I _{OL} = 5.2 mA	6 V		0.15	0.26		0.4		0.33	
		Q_A-Q_H , $I_{OL} = 7.8 \text{ mA}$	бV		0.15	0.26		0.4		0.33	
Ц	$V_I = V_{CC} \text{ or } 0$		6 V		±0.1	±100		±1000		±1000	nA
I _{OZ}	$V_{O} = V_{CC} \text{ or } 0$		6 V		±0.01	±0.5		±10		±5	μΑ
Icc	$V_I = V_{CC} \text{ or } 0,$	I _O = 0	6 V			8		160		80	μΑ
Ci			2 V to 6 V		3	10		10		10	pF



SN54HC590A, SN74HC590A **8-BIT BINARÝ COUNTERS** WITH 3-STATE OUTPUT REGISTERS SCLS039F - DECEMBER 1982 - REVISED SEPTEMBER 2003

timing requirements over recommended operating free-air temperature range (unless otherwise noted)

				T _A =	25°C	SN54H	C590A	SN74H	C590A	
			VCC	MIN	MAX	MIN	MAX	MIN	MAX	UNIT
			2 V		4		2.5		3.2	
fclock	Clock frequency		4.5 V		20		13		16	MHz
			6 V		24		16		19	
			2 V	125		200		155		
		CCLK or RCLK high or low	4.5 V	25		38		31		
	Dulas duration		6 V	21		32		26		
tw	Pulse duration		2 V	100		150		125		ns
		CCLR low	4.5 V	20		30		25		
			6 V	17		26		21		
			2 V	100		150		125		
		CCKEN low before CCLK1	4.5 V	20		30		25		
			6 V	17		26		21		
			2 V	100		150		125		
t _{su}	Setup time	CCLR high (inactive) before CCLK1	4.5 V	20		30		25		ns
			6 V	17		26		21		
			2 V	100		150		125		
		CCLK↑ before RCLK↑†	4.5 V	20		30		25		
			6 V	17		26		21		
			2 V	50		75		60		
^t h	Hold time	CCKEN low after CCLK↑		10		15		12		ns
						13		11		

[†] This setup time ensures that the register gets stable data from the counter outputs. The clocks may be tied together, in which case the register is one clock pulse behind the counter.



SN54HC590A, SN74HC590A **8-BIT BINARY COUNTERS** WITH 3-STATE OUTPUT REGISTERS SCLS039F - DECEMBER 1982 - REVISED SEPTEMBER 2003

switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

					SN	54HC59	0A		
PARAMETER	FROM (INPUT)	TO (OUTPUT)	Vcc	Т	ן = 25°C	;			UNIT
		(001101)		MIN	TYP	MAX	MIN	MAX	
			2 V	4	8		2.5		
fmax			4.5 V	20	35		13		MHz
			6 V	24	40		16		
			2 V		80	150		225	
^t pd	CCLK↑	RCO	4.5 V		20	31		45	ns
•			6 V		15	26		38	
			2 V		70	130		195	
^t PLH	CCLR↓	RCO	4.5 V		18	28		39	ns
			6 V		14	23		33	
		Q	2 V		70	140		210	
^t pd	RCLK↑		4.5 V		18	31		42	ns
•			6 V		14	25		36	
			2 V		80	125		185	
^t en	OE↓	Q	4.5 V		20	30		37	ns
			6 V		15	28		31	
			2 V		80	125		185	
^t dis	OE↑	Q	4.5 V		20	30		37	ns
			6 V		15	28		31	
			2 V		38	75		110	
		RCO	4.5 V		8	15		22	
tť*			6 V		6	13		19	~~
ч		2	2 V		38	60		90	ns
			4.5 V		8	12		18	
			6 V		6	10		15	

* This parameter is not production tested for the SN54HC590A.



SN54HC590A, SN74HC590A **8-BIT BINARÝ COUNTERS** WITH 3-STATE OUTPUT REGISTERS SCLS039F – DECEMBER 1982 – REVISED SEPTEMBER 2003

switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

					SN	74HC59	0A		
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC}	т	₄ = 25° Ω	;			UNIT
		(001101)		MIN	TYP	MAX	MIN	MAX	
			2 V	4	8		3.2		
fmax			4.5 V	20	35		16		MHz
			6 V	24	40		19		
			2 V		80	150		190	
^t pd	CCLKÎ	RCO	4.5 V		20	30		38	ns
			6 V		15	26		33	
			2 V		70	130		165	
^t PLH	CCLR↓	RCO	4.5 V		18	26		33	ns
			6 V		14	22		28	
	RCLKÎ	Q	2 V		70	140		175	
^t pd			4.5 V		18	28		35	ns
			6 V		14	24		30	
			2 V		80	125		155	
^t en	OE↓	Q	4.5 V		20	25		31	ns
			6 V		15	21		26	
			2 V		80	125		155	
^t dis	OE↑	Q	4.5 V		20	25		31	ns
			6 V		15	21		26	
			2 V		38	75		95	
		RCO	4.5 V		8	15		19	
+ ,			6 V		6	13		16	ns
tt			2 V		38	60		75	115
		Q	4.5 V		8	12		15	
			6 V		6	10		13	



SN54HC590A, SN74HC590A **8-BIT BINARY COUNTERS** WITH 3-STATE OUTPUT REGISTERS SCLS039F - DECEMBER 1982 - REVISED SEPTEMBER 2003

switching characteristics over recommended operating free-air temperature range, C_L = 150 pF (unless otherwise noted) (see Figure 1)

					SN	54HC59	0A					
PARAMETER	FROM (INPUT)	TO (OUTPUT)	Vcc	T _A = 25°C					UNIT			
		(001101)		MIN	TYP	MAX	MIN	MAX				
			2 V		100	300		447				
^t pd	RCLK [↑]	Q	4.5 V		24	60		90	ns			
•			6 V		20	51		77				
			2 V		90	200		300				
^t en	OE	Q	4.5 V		23	40		60	ns			
			6 V		19	34		51				
			2 V		45	210		315				
t _t *			Q		Q	4.5 V		17	42		63	ns
			6 V		13	36		53				

* This parameter is not production tested for the SN54HC590A.

switching characteristics over recommended operating free-air temperature range, $C_L = 150 \text{ pF}$ (unless otherwise noted) (see Figure 1)

					SN74	HC59	0A		
PARAMETER	FROM (INPUT)	TO (OUTPUT)	Vcc	T _A = 25°C					UNIT
		(001101)		MIN T	P	MAX	MIN	MAX	
			2 V	1	00	300		380	
^t pd	RCLK↑	Q	4.5 V		24	60		76	ns
•			6 V		20	51		65	
			2 V		90	200		250	
ten	OE	Q	4.5 V		23	40		50	ns
			6 V		19	34		43	
			2 V		45	210		265	
tt		Q	4.5 V		17	42		53	ns
			6 V		13	36		45	

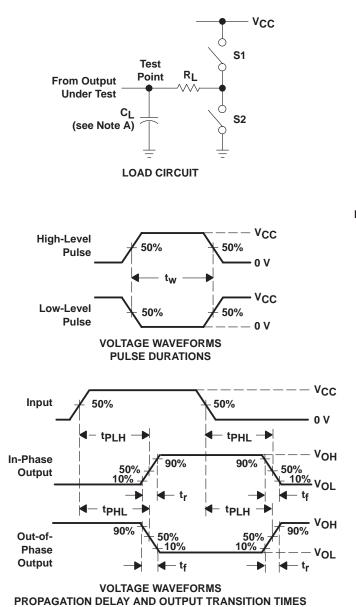
operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	TYP	UNIT
Cpd	Power dissipation capacitance	No load	250	pF

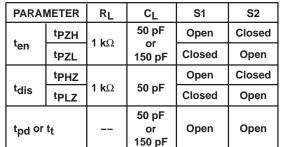


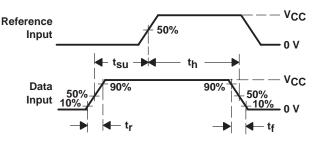
SN54HC590A, SN74HC590A 8-BIT BINARY COUNTERS WITH 3-STATE OUTPUT REGISTERS

SCLS039F - DECEMBER 1982 - REVISED SEPTEMBER 2003

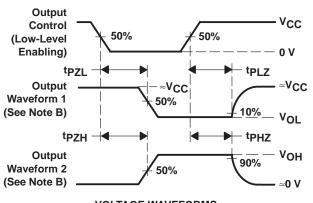


PARAMETER MEASUREMENT INFORMATION



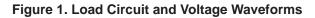


VOLTAGE WAVEFORMS SETUP AND HOLD AND INPUT RISE AND FALL TIMES



VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES FOR 3-STATE OUTPUTS

- NOTES: A. CL includes probe and test-fixture capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_r = 6 ns, t_f = 6 ns.
 - D. The outputs are measured one at a time with one input transition per measurement.
 - E. tpl 7 and tpH7 are the same as tdis.
 - F. tpzL and tpzH are the same as ten.
 - G. tPLH and tPHL are the same as tpd.





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18-Sep-2008

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
5962-89603012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
5962-8960301EA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
5962-8960301FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SN54HC590AJ	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN74HC590AD	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC590ADE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC590ADG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC590ADR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC590ADRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC590ADRG4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC590ADT	ACTIVE	SOIC	D	16	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC590ADTE4	ACTIVE	SOIC	D	16	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC590ADTG4	ACTIVE	SOIC	D	16	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC590ADW	ACTIVE	SOIC	DW	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC590ADWG4	ACTIVE	SOIC	DW	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC590ADWR	ACTIVE	SOIC	DW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC590ADWRG4	ACTIVE	SOIC	DW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC590AN	ACTIVE	PDIP	Ν	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74HC590AN3	OBSOLETE	PDIP	Ν	16		TBD	Call TI	Call TI
SN74HC590ANE4	ACTIVE	PDIP	Ν	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SNJ54HC590AFK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54HC590AJ	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54HC590AW	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type

⁽¹⁾ The marketing status values are defined as follows: ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.



Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device		Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74HC590ADR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74HC590ADWR	SOIC	DW	16	2000	330.0	16.4	10.75	10.7	2.7	12.0	16.0	Q1



PACKAGE MATERIALS INFORMATION

19-Mar-2008



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74HC590ADR	SOIC	D	16	2500	333.2	345.9	28.6
SN74HC590ADWR	SOIC	DW	16	2000	346.0	346.0	33.0

MLCC006B - OCTOBER 1996

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



J (R-GDIP-T**) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only.
 - E. Falls within MIL STD 1835 GDFP1-F16 and JEDEC MO-092AC



D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AC.



D(R-PDSO-G16)



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Refer to IPC7351 for alternate board design.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



DW (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-013 variation AA.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



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